

Crystal oscillator

SEIKO EPSON CORPORATION

LOW-JITTER SAW OSCILLATOR (SPSO) OUTPUT : LV-PECL, LVDS, HCSL



Product Number EG-2121CA: Q3805CAx0xxxx00 : X1M000101xxxx00 EG-2102CA: Q3806CA00xxxx00 : X1M000091xxxx00

EG-2121CA EG-2102CA

Frequency range
Supply voltage •Output •Function : •External dimensions :

53.125 MHz to 700 MHz 2.5 V ... EG-2121CA 3.3 V ... EG-2102CA LV-PECL or LVDS or HCSL Output enable (OE) 7.0 × 5.0 × 1.2 mm

f_aging

•Very low jitter and low phase noise by SAW unit.

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► Differential LV-PECL Outpu		EG-2121CA	EG-2102CA		
Item	Symbol	LV-PECL		Conditions / Remarks	
Output frequency range	fo	53.125 MHz to 500 MHz 100 MHz to 700 MHz F		Please contact us about available frequencies.	
Supply voltage	Vcc	2.5 V ± 0.125 V	3.3 V ± 0.3 V		
Storage temperature	T_stg	-40 C to	+100 C	Storage as single product.	
Operating temperature	T use	P:0 C to +70 C, R: -5 C to	+85 C, S: -20 C to +70 C		
Frequency tolerance	f tol	G: ± 50 × 10 ⁻⁶ ,	H: ±100 × 10 ⁻⁶		
Current consumption	lcc	80 mA Max.	100 mA Max.	OE=Vcc, L ECL=50 Ω	
Disable current	l_dis	20 mA Max.	32 mA Max	OE=GND	
Symmetry	SYM	$\begin{array}{c} {\rm P:40~\%~to~60~\%}\\ ({\rm fo} > 350~{\rm MHz})\\ {\rm P:45~\%~to~55~\%}\\ ({\rm fo} \le 350~{\rm MHz})\\ {\rm D.48~\%~to~52~\%}\\ ({\rm fo} \le 175~{\rm MHz}) \end{array}$	P:45 % to 55 % D:48 % to 52 % (fo ≤ 350 MHz)	at outputs crossing point	
Output voltage	V _{OH} V _{OL}	1.55 V Typ. 2.35 V Typ. Vcc-1.025 V to Vcc-0.88 V 0.8 V Typ. 0.8 V Typ. 1.6 V Typ. Vcc-1.81 V to Vcc-1.62 V 1.6 V Typ.		DC characteristics	
Output load condition (ECL)	L ECL	50 Ω		Terminated to Vcc -2.0 V	
nput voltage	Vili Vili	70 % Vee Min		-OE terminal	
Rise time / Fall time	tr / tf			Between 20 % and 80 % of	(VOH-VOL)
Start-up time	t_str	10 ms Max.		Time at minimum supply vol	
Phase Jitter	hase Jitter tej 0.8 ps Max.			fo < 100 MHz 100 MHz ≤ fo < 200 MHz	Offset frequency: 12 kHz
	4-3	0.3 ps Max		$\frac{100 \text{ MHz} \le 10 < 200 \text{ MHz}}{200 \text{ MHz}} = 20 \text{ MHz}$	

0.3 ps Max.

± 10 × 10⁻⁶ / year Max.

200 MHz ≤ fo

+25 C, First year, Vcc=2.5 V, 3.3 V

► LVDS Output

Frequency aging

Item	Cumbal	EG-2121CA	EG-2102CA	Conditions	/ Domarka
nem	Symbol	LVDS		Conditions / Remarks	
Output frequency range	fo	53.125 MHz to 700 MHz		Please contact us about available frequencies.	
Supply voltage	Vcc	2.5 V ± 0.125 V 3.3 V ± 0.3 V			
Storage temperature	T stg	-40 C to	+100 C	Storage as single product.	
Operating temperature	T_use	P:0 C to +70 C, R: -5 C to	+85 C, S: -20 C to +70 C		
Frequency tolerance	f_tol	G: ± 50 × 10 ⁻⁶ ,	H: ±100 × 10 ⁻⁶		
Current consumption	lcc	30 mA Max	45 mA Max.	OE=Vcc, L LVDS= 100 Ω	
Disable current	l_dis	20 mA Max	30 mA Max.	OE=GND	
Symmetry	SYM	L:40 % to 60 % (fo > 350 MHz) L:45 % to 55 % (fo ≤ 350 MHz)	L:40 % to 60 % (fo > 350 MHz) L:45 % to 55 % (fo ≤ 350 MHz)	at outputs crossing point	
		V:48 % to 52 % (fo ≤ 175 MHz)	V:48 % to 52 % (fo≤ 175 MHz)		
	Vod	350 mV Typ. 247 mV to 454 mV		VOD1, VOD2	
Output voltage	dVop			dVod = Vod1-Vod2	DC characteristics
Output Voltage	Vos	1.25 V Typ. 1.125 V to 1.375 V		Vos1, Vos2	
	dVos	150 mV Max.		dVos = Vos1-Vos2	
Output load condition (LVDS)	L_LVDS	100 Ω		Connected between OUT to	
Input voltage	VIH	70 % V _{cc} Min.		OE terminal	
Input voltage	VIL	30 % Vcc Max.		OE terminal	
Rise time / Fall time	tr / tr			Between 20 % and 80 % o Peak voltage	f Differential Output Peak to
Start-up time	t_str	10 ms Max.		Time at minimum supply vo	tage to be 0 s
	tрj	0.8 ps Max.		fo < 100 MHz	Offset frequency: 12 kHz to
Phase Jitter		0.5 ps Max.		100 MHz ≤ fo < 200 MHz	-20 MHz
		0.3 ps Max.		200 MHz ≤ fo	
Frequency aging	f_aging	± 10 × 10 ⁻⁶	/ year Max.	+25 C, First year, Vcc=2.5	V, 3.3 V

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HCSL Output

Item	Symbol	EG-2121CA	EG-2102CA	Condition	/ Romarke
nem		HCSL		Conditions / Remarks	
Output frequency range	fo	100 MHz to 350 MHz P		Please contact us about available frequencies.	
Supply voltage	Vcc	2.5 V ± 0.125 V 3.3 V ± 0.3 V			
Storage temperature	T_stg	-40 C to	+125 C	Storage as single product.	
Operating temperature	T_use	P:0 C to +70 C, R: -5 C to	+85 C, S: -20 C to +70 C		
Frequency tolerance	f_tol	G: ± 50 × 10 ⁻⁶ ,	H: ±100 × 10 ⁻⁶		
Current consumption	lcc	80 mA Max.	85 mA Max.	OE=Vcc, L HCSL=50 Ω	
Disable current	l_dis	20 mA Max.	35 mA Max OE=GND		
Symmetry	SYM	45 % to 55 % a		at outputs crossing point	
Output Voltage	V _{OH}	0.75 V Typ.		DC characteristics	
Ouput voltage	VoL	-0.3 V Typ.			
Output load condition (HCSL)	L HCSL	50 Ω		Terminated to GND	
Input voltage	VIH	70 % V _{CC} Min.		OE terminal	
	VIL	30 % V _{cc} Max.			
Rise time / Fall time	tr/tr	500 ps Max.		Between 0.175 V and 0.525	5 V of output
Start-up time	t str	10 ms Max.		Time at minimum supply vo	Itage to be 0 s
		0.8 ps Max.		fo < 100 MHz	Offset frequency: 12 kHz to
Phase Jitter	teu	0.5 ps Max.		100 MHz ≤ fo < 200 MHz	-20 MHz
		0.3 ps	Max.	200 MHz ≤ fo	
Frequency aging *2	f_aging	± 10 × 10 ⁻⁶ / year Max.		+25 C, First year, Vcc=2.5	V, 3.3 V

Product Name (Standard form) EG-2121 CA 250.000000MHz P G P A ① ② ③ ④⑤⑥⑦

OModel
 @Package type
 ③Frequency

(4) Output/Symmetry (5) Frequency tolerance (6) Operating temperature

⑦ Frequency aging (A*1: Frequency tolerance include aging, N*2: Frequency tolerance exclude aging)

*1 This includes initial frequency tolerance, temperature variation, supply voltage change, reflow drift, and aging(+25 C,10 years).
 *2 This includes initial frequency tolerance, temperature variation, supply voltage change, and reflow drift(except aging).
 (5)607: GRA, GSA are not available)

(⑤⑥: As for LV-PECL and LVDS output, for 53.125 MHz ≤ fo < 100 MHz only HP is available)

(00)						
4	Output	Symmetry			5 Frequency tolerance	
Symbol	Output	EG-2121CA	EG-2102CA	G	±50 × 10 ⁻⁶	
Ρ	LV-PECL	40 % to 60 %(fo > 350 MHz) 45 % to 55 %(fo ≤ 350 MHz)	45 % to 55 %	Н	±100 × 10 ⁻⁸	
D	LV-PECL	48 % to 52 %(fo≤ 175 MHz)	<u>60</u>			
L	LVDS	40 % to 60 %(to > 350 MHz) 45 % to 55 %(to ≤ 350 MHz)			-5 °C to +85 °C -20 °C to +70 °C	
V	LVDS	48 % to 52 %(fo ≤ 175 MHz)				
Н	HCSL	45 % to 55 %				

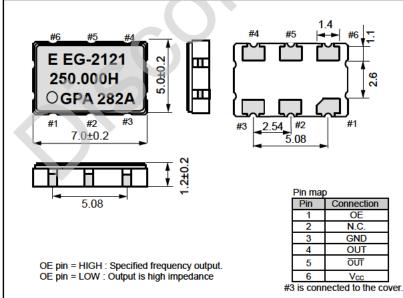
Table 2 Jitter

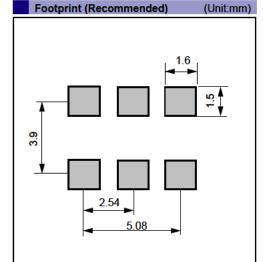
Item	Symbol	Specifications	Remarks	
	tou	0.2 ps Typ.	Deterministic Jitter	
	t _{RJ}	3 ps Typ.	Random Jitter	
Jitter *	t _{RMS}	3 ps Typ.	σ (RMS of total distribution)	
	t _{p-p}	25 ps Typ.	Peak to Peak	
	t _{acc}	4 ps Typ.	Accumulated Jitter(o) n=2 to 50 000 cycles	

(Unit:mm)

* Tested using a DTS-2075 Digital iming system made by WAVECREST with jitter analysis software VISI6. : Differential LV-PECL, LVDS output * Based on SIA-3100C signal integrity analyzer made from WAVECREST. : HCSL output

External dimensions





To maintain stable opera ion, provide a 0.01 uF to 0.1 uF by-pass capacitor at a location as near as possible to the power source terminal of the crystal product (between Vcc - GND).

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At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

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IATF 16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

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